

APPLICATION DATA SHEET**Inventor Information**

Inventor One Given Name : Gundu M.
Family Name : Sabde
Postal Address Line One : 1524 River Stone Ln. #2
City : Boise
State or Province : Idaho
County : Ada
Postal or Zip Code : 83706
City of Residence : Boise
State or Prov. Of Residence : Idaho
Country of Residence : USA
Citizenship Country : India

Inventor Two Given Name : Whonchee
Family Name : Lee
Postal Address Line One : 493 S. Browning Avenue
City : Boise
State or Province : Idaho
County : Ada
Postal or Zip Code : 83709
City of Residence : Boise
State or Prov. Of Residence : Idaho
Country of Residence : USA
Citizenship Country : USA

Correspondence Information

Name Line One : Steven H. Arterberry, Esq.
Address Line One : DORSEY & WHITNEY LLP
Address Line Two : 1420 Fifth Avenue, Suite 3400
City : Seattle
State or Province : Washington
Postal or Zip Code : 98101
Telephone : 206-903-8800
Facsimile : 206-903-8820
E-Mail : arterberry.steve@dorseylaw.com

Application Information

Title : METHODS AND APPARATUSES FOR PLANARIZING
MICROELECTRONIC SUBSTRATE ASSEMBLIES
Total Drawing Sheets : 4 (FOUR)
Formal Drawings : YES
Application Type : Utility
Attorney Docket Number : 500163.04
Assigned : Yes (Large Entity)

Representative Information

Representative Customer No. : 27,076

Continuity Information

This application is a : divisional of
>Application One : 09/356,808
Filing Date : July 20, 1999

\sefile05\files2\ip\documents\clients\micron technology\100\500163.04\500163.04 application data sheet.doc